

Technical Notice

Issue Date: Dec. 2, 2016

Product Name:
WAFER-CV-D25501/WAFER-CV-N26001

Implementation Date: Dec. 2

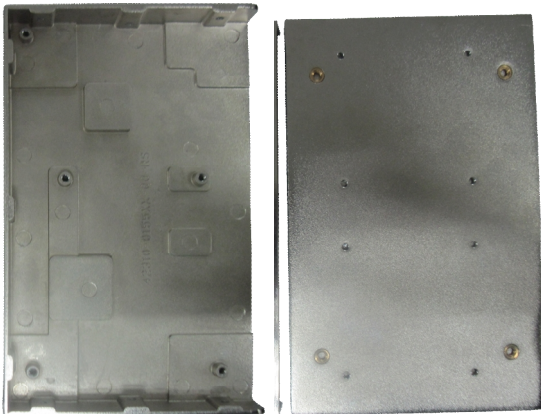
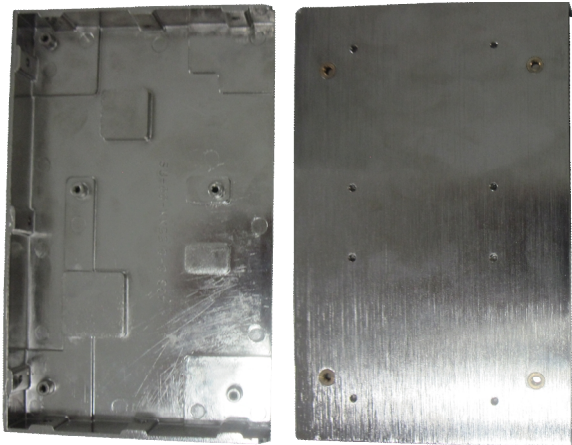
This notice is to inform you of changes to the WAFER-CV-D25501& WAFER-CV-N26001 series.

Reason for Change

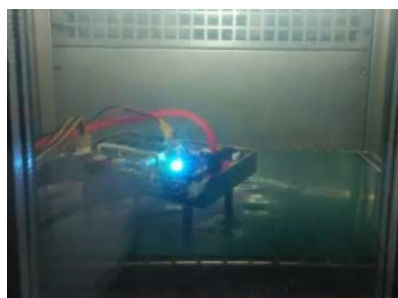
Change heatsink vendor

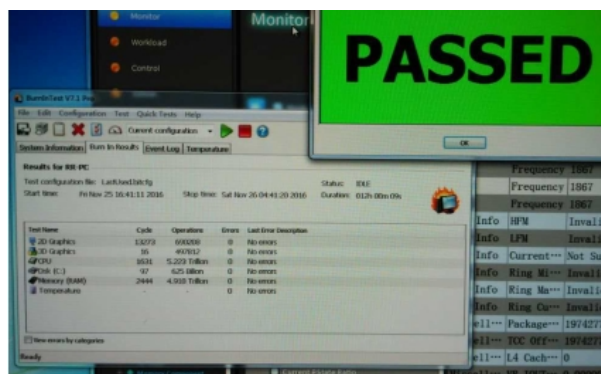
Description of Change.

Change heatsink vendor and the material surface from nickel plating with sandblasting to nickel plating with satin finish

Original item	Substitute item
	

Burn In Test: PASS





Temperature (°C)	Humidity (%)	Time (H)
65	95	12
-20	0	12

Affected Model

Affected Model
WAFER-CV-D25501-R10
WAFER-CV-N26001-R10

Affected by This Change

- ☐ Specifications
 ☐ Dimensions
 ☒ Appearance
 ☐ Package
☐ Certification
 ☐ Label
 ☐ BIOS
 ☐ Driver

For more details please refer to the latest datasheet or visit <http://www.ieiworld.com>.

Best Regards,
Elinor Chuang
Product Manager
IEI Integration Corp.